

## Portable Power Management 300mA Dual LDO Regulator

### **General Description**

The RT9011 is a dual channel, low noise, and low dropout regulator sourcing up to 300mA at each channel. The range of output voltage is from 1.2V to 3.6V by operating from 2.5V to 5.5V input.

RT9011 offers 2% accuracy, extremely low dropout voltage (240mV @ 300mA), and extremely low ground current, only  $27\mu A$  per LDO. The shutdown current is near zero current which is suitable for battery-power devices. Other features include current limiting, over temperature, output short circuit protection.

RT9011 is short circuit thermal folded back protected. RT9011 lowers its OTP trip point from 165°C to 110°C when output short circuit occurs (VOUT < 0.4V) providing maximum safety to end users.

RT9011 can operate stably with very small ceramic output capacitors, reducing required board space and component cost. RT9011 is available in fixed output voltages in the TSOT-23-6 and WDFN-8L 2x2 package.

### **Ordering Information**

RT9011-DDDDDCACAGE Type
J6: TSOT-23-6
QW: WDFN-8L 2x2 (W-Type)
Operating Temperature Range
P: Pb Free with Commercial Standard
G: Green (Halogen Free with Commercial Standard)
Output Voltage: VOUT1/VOUT2
CM: 1.20V/2.80V, FM: 1.50V/2.80V
GK: 1.80V/2.60V, GS: 1.80V/3.30V
JG: 2.50V/1.80V, JM: 2.50V/2.80V
JP: 2.50V/3.00V, JS: 2.50V/3.30V

JG: 2.50V/1.80V, JM: 2.50V/2.80V JP: 2.50V/3.00V, JS: 2.50V/3.30V JN: 2.50V/2.85V, MG: 2.80V/1.80V MM: 2.80V/2.80V, NN: 2.85V/2.85V MS: 2.80V/3.30V, PG: 3.00V/1.80V MP: 2.80V/3.00V, PP: 3.00V/3.00V SS: 3.30V/3.30V, SQ: 3.30V/3.10V

BM: 1.30V/2.80V

Note:

RichTek Pb-free and Green products are :

- ▶RoHS compliant and compatible with the current requirements of IPC/JEDEC J-STD-020.
- ▶Suitable for use in SnPb or Pb-free soldering processes.
- ▶100% matte tin (Sn) plating.

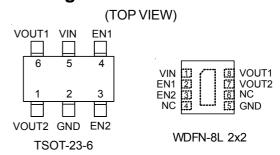
#### **Features**

- Wide Operating Voltage Ranges : 2.5V to 5.5V
- Low-Noise for RF Application
- No Noise Bypass Capacitor Required
- Fast Response in Line/Load Transient
- TTL-Logic-Controlled Shutdown Input
- Low Temperature Coefficient
- Dual LDO Outputs (300mA/300mA)
- Ultra-low Quiescent Current 27µA/LDO
- High Output Accuracy 2%
- Short Circuit Protection
- Thermal Shutdown Protection
- Current Limit Protection
- Short Circuit Thermal Folded Back Protection
- Tiny TSOT-23-6 and 8-Lead WDFN Package
- RoHS Compliant and 100% Lead (Pb)-Free

### **Applications**

- CDMA/GSM Cellular Handsets
- Battery-Powered Equipment
- Laptop, Palmtops, Notebook Computers
- Hand-Held Instruments
- PCMCIA Cards
- Portable Information Appliances

### **Pin Configurations**



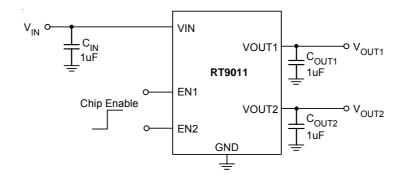
**Note**: There is no pin1 indicator on top mark for TSOT-23-6 type, and pin 1 will be lower left pin when reading top mark from left to right.

## **Marking Information**

For marking information, contact our sales representative directly or through a RichTek distributor located in your area, otherwise visit our website for detail.



# **Typical Application Circuit**



# **Functional Pin Description**

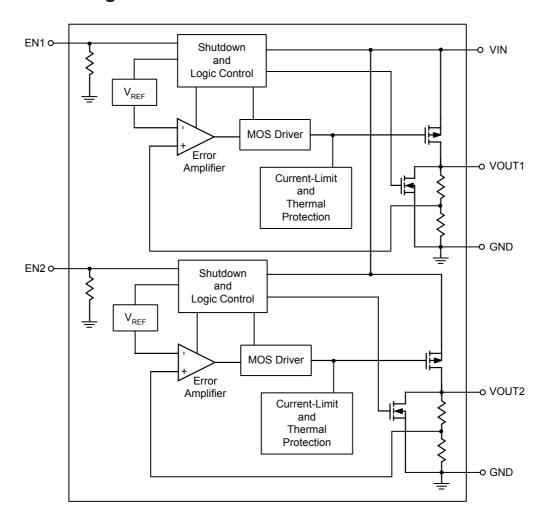
Pin No.		D' N	Din Function		
RT9011-□□PQW	RT9011-□□PJ6	Pin Name	Pin Function		
1	5	VIN	Supply Input		
2	4	EN1	Chip Enable1 (Active High)		
3	3	EN2	Chip Enable2 (Active High)		
5	2	GND	Common Ground		
7	1	VOUT2	Channel 2 Output Voltage		
8	6	VOUT1	Channel 1 Output Voltage		
4, 6	-	NC	No Connection		
Exposed Pad	-	GND	Exposed pad should be soldered to PCB board and connected to GND.		

## **Available Voltage Version**

Code	С	В	F	W	G	D	Y	Н	Е	J	K
Voltage	1.2	1.3	1.5	1.6	1.8	1.85	1.9	2	2.1	2.5	2.6
Code	Т	L	М	N	V	Р	Q	R	S		
Voltage	2.65	2.7	2.8	2.85	2.9	3	3.1	3.2	3.3		-



# **Function Block Diagram**





# Absolute Maximum Ratings (Note 1)

Supply Input Voltage	6V
• Other I/O Pin Voltages	6V
<ul> <li>Power Dissipation, P<sub>D</sub> @ T<sub>A</sub> = 25°C</li> </ul>	
TSOT23-6	0.455W
WDFN-6L 2x2	0.606W
Package Thermal Resistance (Note 4)	
TSOT23-6, $\theta_{JA}$	220°C/W
WDFN-6L 2x2, $\theta_{JA}$	165°C/W
• Lead Temperature (Soldering, 10 sec.)	260°C
Storage Temperature Range	65°C to 150°C
ESD Susceptibility (Note 2)	
HBM (Human Body Mode)	2kV
MM (Machine Mode)	200V
Recommended Operating Conditions (Note 3)	
• Supply Input Voltage	2.5V to 5.5V
• Enable Input Voltage	0V to 5.5V

#### **Electrical Characteristics**

 $(V_{IN} = V_{OUT} + 1V, V_{EN} = V_{IN}, C_{IN} = C_{OUT} = 1\mu F, T_A = 25^{\circ}C$ , unless otherwise specified.)

Parameter	Symbol	Test Conditions	Min	Тур	Max	Units	
Input Voltage	V <sub>IN</sub>	V <sub>IN</sub> = 2.5V to 5.5V	2.5		5.5	V	
Dropout Voltage (Note 5)	$V_{DROP}$	I <sub>OUT</sub> = 300mA		240	330	mV	
Output voltage range	V <sub>OUT</sub>		1.2		3.6	V	
V <sub>OUT</sub> Accuracy	ΔV	I <sub>OUT</sub> = 1mA	-2		+2	%	
Line Regulation	ΔV <sub>LINE</sub>	$V_{IN}$ = ( $V_{OUT}$ + 0.3V) to 5.5V or $V_{IN}$ > 2.5V, whichever is larger			0.2	%/V	
Load Regulation	$\Delta V_{LOAD}$	1mA < I <sub>OUT</sub> < 300mA	-		0.6	%	
Current Limit		$R_{LOAD}$ = 1 $\Omega$	330	450	700	mA	
Quiescent Current	IQ	V <sub>EN</sub> > 1.5V		58	80	μА	
Shutdown Current	I <sub>Q_SD</sub>	V <sub>EN</sub> < 0.4V			1	μΑ	
EN Threshold	V <sub>IH</sub>	V <sub>IN</sub> = 2.5V to 5.5V, Power On	1.5			V	
LIN THI ESTICIO	V <sub>IL</sub>	V <sub>IN</sub> = 2.5V to 5.5V, Shutdown			0.4	]	
Output Voltage TC				100		ppm/°C	
Thermal Shutdown	T <sub>SD</sub>			170		°C	
Thermal Shutdown Hysteresis	$\Delta T_{SD}$			40		°C	

To be continued

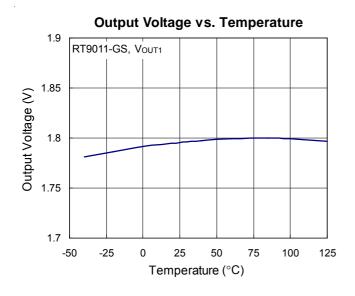


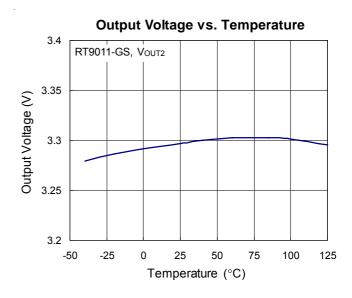
Parameter	Symbol	Test Conditions	Min	Тур	Max	Units
DODD	PSRR	f =100Hz		65		dB
PSRR I <sub>LOAD</sub> = 10mA		f =1kHz		60		dB
LOAD		f =10kHz		50		dB
DODD	PSRR	f =100Hz		65		dB
PSRR I <sub>LOAD</sub> = 150mA		f=1kHz		50		dB
LOAD TOOM!		f=10kHz		50		dB

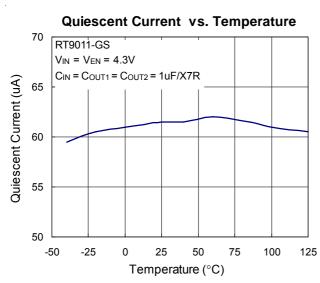
- **Note 1.** Stresses listed as the above "Absolute Maximum Ratings" may cause permanent damage to the device. These are for stress ratings. Functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may remain possibility to affect device reliability.
- Note 2. Devices are ESD sensitive. Handling precaution recommended.
- Note 3. The device is not guaranteed to function outside its operating conditions.
- Note 4.  $\theta_{JA}$  is measured in the natural convection at  $T_A$  = 25°C on a low effective thermal conductivity test board of JEDEC 51-3 thermal measurement standard.
- Note 5. The dropout voltage is defined as  $V_{IN}$  - $V_{OUT}$ , which is measured when  $V_{OUT}$  is  $V_{OUT(NORMAL)}$  100mV.

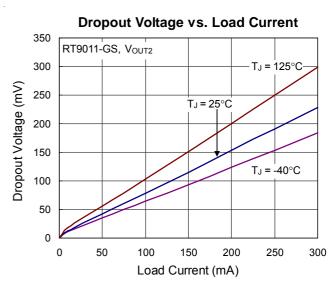


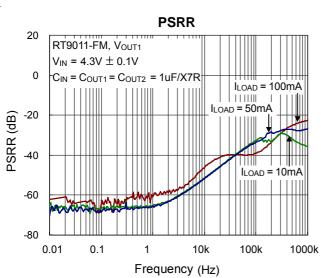
## **Typical Operating Characteristics**

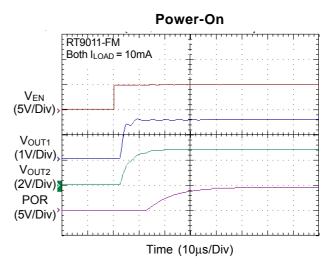




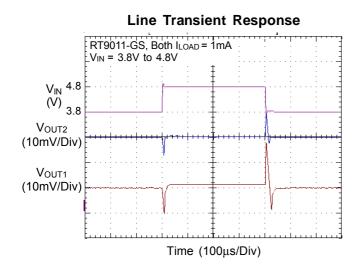


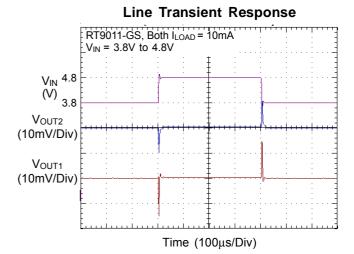


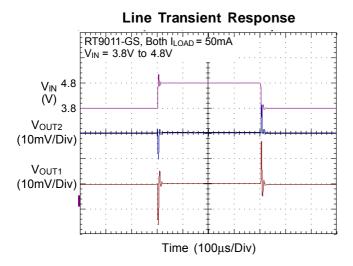


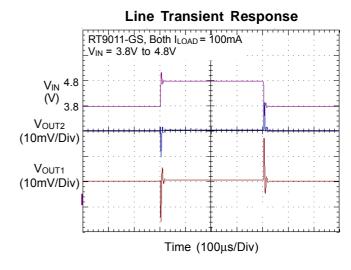


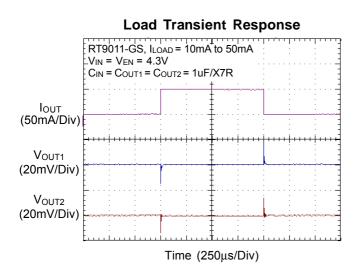


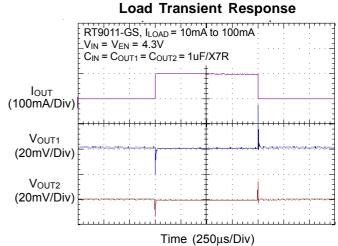




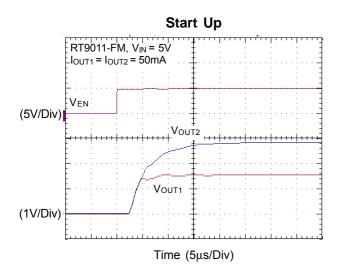


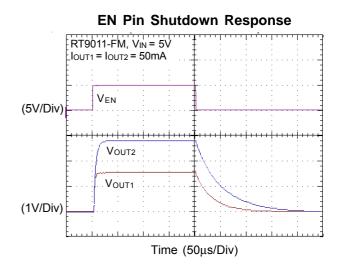


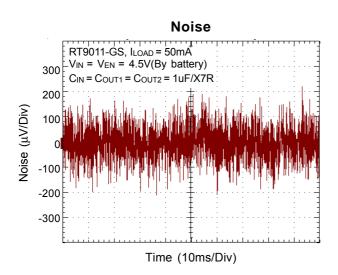


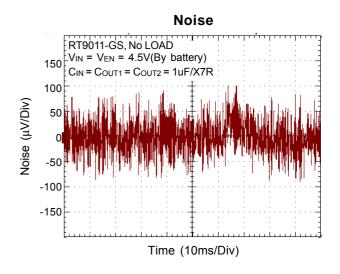














### **Applications Information**

Like any low-dropout regulator, the external capacitors used with the RT9011 must be carefully selected for regulator stability and performance. Using a capacitor whose value is >  $1\mu F$  on the RT9011 input and the amount of capacitance can be increased without limit. The input capacitor must be located a distance of not more than 0.5 inch from the input pin of the IC and returned to a clean analog ground. Any good quality ceramic or tantalum can be used for this capacitor. The capacitor with larger value and lower ESR (equivalent series resistance) provides better PSRR and line-transient response.

The output capacitor must meet both requirements for minimum amount of capacitance and ESR in all LDOs application. The RT9011 is designed specifically to work with low ESR ceramic output capacitor in space-saving and performance consideration. Using a ceramic capacitor whose value is at least  $1\mu F$  with ESR is >  $20m\Omega$  on the RT9011 output ensures stability. The RT9011 still works well with output capacitor of other types due to the wide stable ESR range. Figure 1. shows the curves of allowable ESR range as a function of load current for various output capacitor values. Output capacitor of larger capacitance can reduce noise and improve load transient response, stability, and PSRR. The output capacitor should be located not more than 0.5 inch from the VOUT pin of the RT9011 and returned to a clean analog ground.

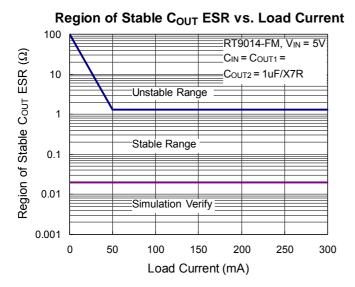


Figure 1. Stable Cout ESR Range

#### **Thermal Considerations**

Thermal protection limits power dissipation in RT9011. When the operation junction temperature exceeds 170°C, the OTP circuit starts the thermal shutdown function and turns the pass element off. The pass element turn on again after the junction temperature cools by 40°C. RT9011 lowers its OTP trip level from 170°C to 110°C when output short circuit occurs (VOUT < 0.4V) as shown in Figure 2. It limits IC case temperature under 100°C and provides maximum safety to customer while output short circuit occurring.

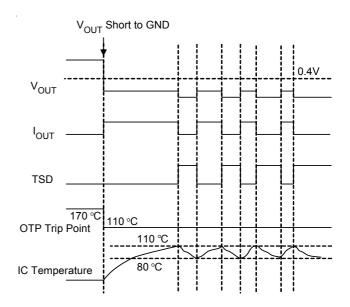


Figure 2. Short Circuit Thermal Folded Back Protection when Output Short Circuit Occurs (Patent)

For continuous operation, do not exceed absolute maximum operation junction temperature 125°C. The power dissipation definition in device is:

$$P_D = (V_{IN}-V_{OUT}) \times I_{OUT} + V_{IN} \times I_{Q}$$

The maximum power dissipation depends on the thermal resistance of IC package, PCB layout, the rate of surroundings airflow and temperature difference between junction to ambient. The maximum power dissipation can be calculated by following formula:

$$P_{D(MAX)} = (T_{J(MAX)} - T_A)/\theta_{JA}$$

Where  $T_{J(MAX)}$  is the maximum operation junction temperature 125°C,  $T_A$  is the ambient temperature and the  $\theta_{JA}$  is the junction to ambient thermal resistance.

For recommended operating conditions specification of RT9011, where  $T_{J(MAX)}$  is the maximum junction temperature of the die (125°C) and  $T_A$  is the operated ambient temperature. The junction to ambient thermal resistance ( $\theta_{JA}$  is layout dependent) for TSOT-23-6 package is 220°C/W and WDFN-8L 2x2 is 165°C/W on the standard JEDEC 51-3 single-layer thermal test board. The maximum power dissipation at  $T_A$  = 25°C can be calculated by following formula :

 $P_{D(MAX)} = (125^{\circ}C - 25^{\circ}C) / 220 = 0.455 \text{ W for TSOT-23-6}$  packages

 $P_{D(MAX)}$  = ( 125°C - 25°C ) / 165 = 0.606 W for WDFN-8L 2x2 packages

The maximum power dissipation depends on operating ambient temperature for fixed  $T_{J(MAX)}$  and thermal resistance  $\theta_{JA}$ . For RT9011 packages, the Figure 3 of derating curves allows the designer to see the effect of rising ambient temperature on the maximum power allowed.

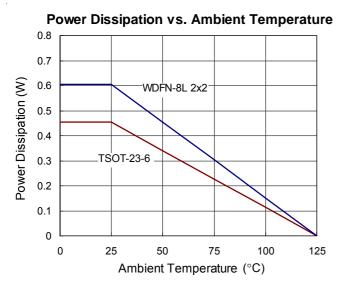
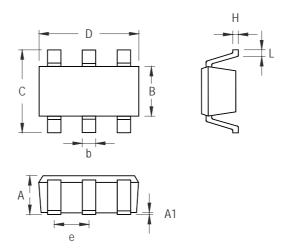


Figure 3. Derating Curves for RT9011 Packages

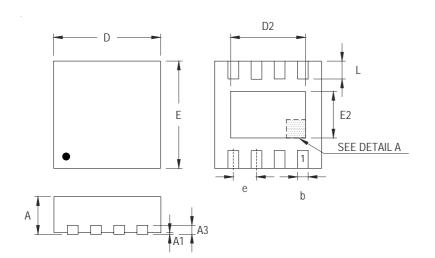


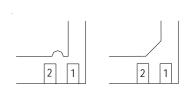
## **Outline Dimension**



Symbol	Dimensions	n Millimeters	Dimensions In Inches			
	Min	Max	Min	Max		
А	0.700	1.000	0.028	0.039		
A1	0.000	0.100	0.000	0.004		
В	1.397	1.803	0.055	0.071		
b	0.300	0.559	0.012	0.022		
С	2.591	3.000	0.102	0.118		
D	2.692	3.099	0.106	0.122		
е	0.838	1.041	0.033	0.041		
Н	0.080	0.254	0.003	0.010		
Ĺ	0.300	0.610	0.012	0.024		

**TSOT-23-6 Surface Mount Package** 





**DETAIL A**Pin #1 ID and Tie Bar Mark Options

Note: The configuration of the Pin#1 identifier is optional, but must be located within the zone indicated.

Symbol	Dimensions I	n Millimeters	Dimensions In Inches			
	Min	Max	Min	Max		
А	0.700	0.800	0.028	0.031		
A1	0.000	0.050	0.000	0.002		
A3	0.175	0.250	0.007	0.010		
b	0.200	0.300	0.008	0.012		
D	1.950	2.050	0.077	0.081		
D2	1.000	1.250	0.039	0.049		
Е	1.950	2.050	0.077	0.081		
E2	0.400	0.650	0.016	0.026		
е	0.500		0.0	)20		
L	0.300	0.400	0.012	0.016		

W-Type 8L DFN 2x2 Package

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